

Notes :

- * Housing : Nylon 9T UL 94V-0
- * Insert housing : Nylon 46 UL 94V-0
- * Contact : Phosphor Bronze, $t = 0.35\text{mm}$
- * Shield: Copper alloy with Nickel plated, $t = 0.20\text{mm}$
- * For Lead-Free IR Reflow process

Ordering Code:

CJ01 88 J 1 1 SM
① ② ③ ④ ⑤ ⑥

① Series No.

② Contacts:

88 = 8P8C

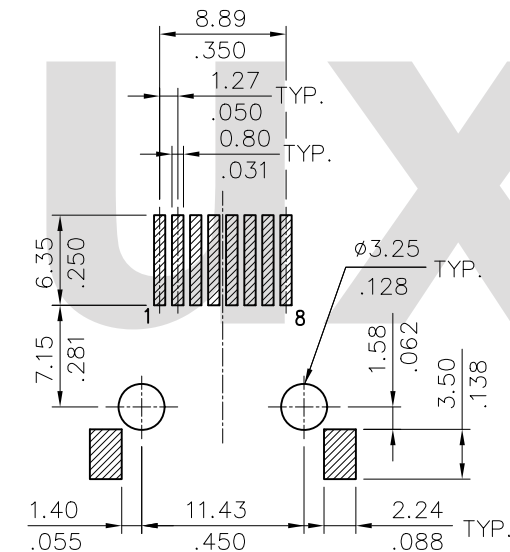
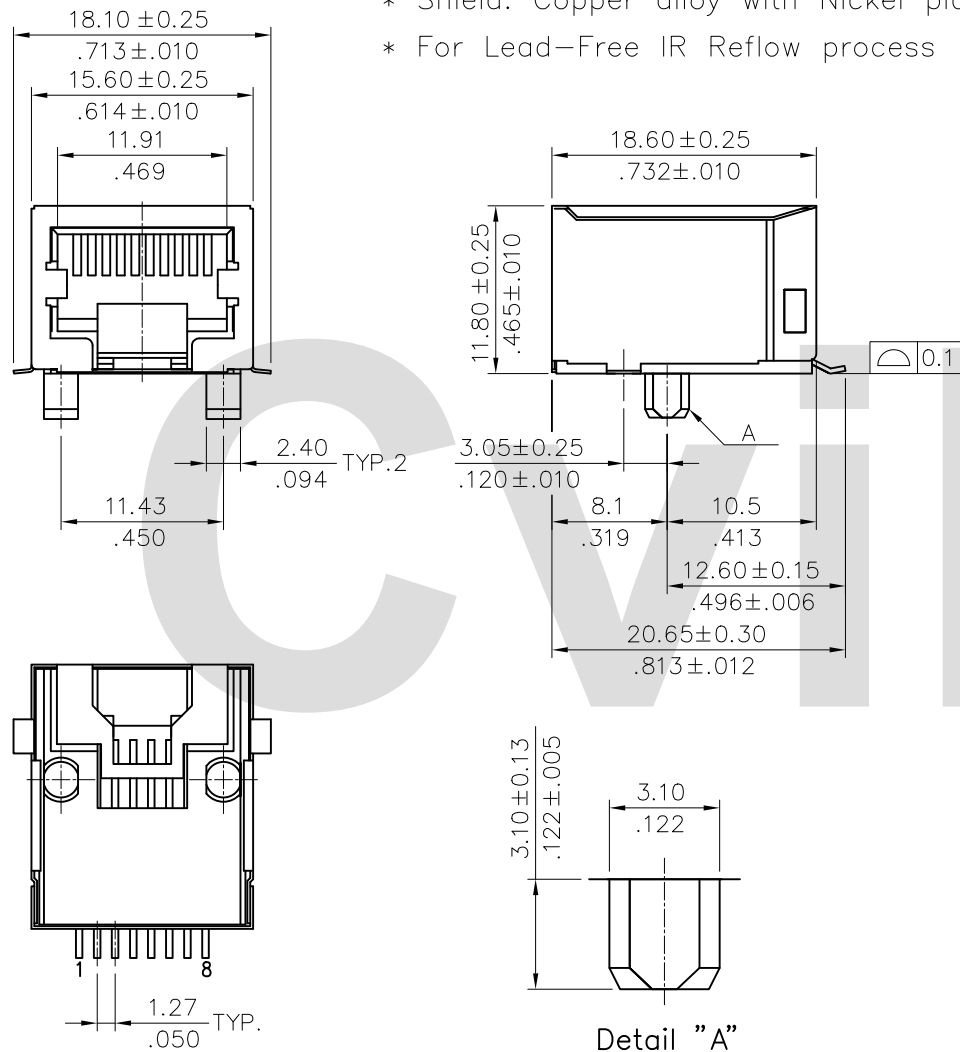
③ Plating option:

J = $0.15\mu\text{m}(6\mu)$ Min. Gold Plating
on Contact area, Gold Flash on
Solder area, Nickel Underplating
over all

④ Ports: 1 = 1 port

⑤ Insulator Color: 1 = Black

⑥ Options: SM = SMT Type



Solder Pad Pattern

Lead Free Process

RoHS Compliant

④						DATE	UNIT: mm / inch	TITLE: BOARD MOUNT LOW PROFILE SMT TYPE TELEPHONE JACK	 瀚荃股份有限公司 CviLux Corporation				
③						DRAWN BY: Sandy	5/26-15'	TOLERANCE UNLESS OTHERWISE SPECIFIED					
②						ENGINEER: Sun	5/26-15'	.X ± 0.38 / .015 X' ± 2"					
①						CHECKED BY: Eisley	5/27-15'	.XX ± 0.25 / .010 X' ± 1"					
SYM	NAME	DATE	REVISIONS			APPROVED BY: Eisley	5/27-15'	.XXX ± 0.13 / .005 XX ±	FINISH:	DRAWING NO. CJ0101SA	PART NO.	CJ0188J11SM	
										SCALE	2 / 1	SHEET	1 OF 1

CVILUX CORP
2015.06.04
ISSUED